

BH7868FS

Features

Type

Structure

Product name

- 1) Built-in LPF with characteristics suited to DVD players and recorders
- 2) Built-in 6-output video driver for Y signal, C signal, Y/C MIX signal, and Py/G, Pb/B, Pr/R signals
- 3) Three circuits drivable for Y signal, C signal, and Y/C MIX signal, and two circuits for Py/G, Pb/B, Pr/R signals
- 4) Built-in sag correction circuit
- 5) Built-in S1/S2 output function

OAbsolute Maximum Ratings(Ta=25°C)

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Parameter	Symbol	Limits	Unit
Supply voltage	VccMAX	6.0	V
Power dissipation	Pd	0.95 *1	W
Operating temperature	Topr	-40 ~ +70	°C
Storage temperature	Tstg	-55 ~ +150	°C

*1 Deratings in done at 7.6mW/°C above Ta=25°C (When mounted on a 70mm × 70mm × 1.6mm PCB board).

OOperating Range (Ta=25°C)

Parameter	Symbol	Limits	Unit
Supply voltage	Vcc	+4.5 ~ +5.5	V

* This product is not designed for protection against radioactive rays.

Application example

The product described in this specification is designed to be used with ordinary electronic equipment or devices (such as audio-visual equipment, office-automation equipment, communications devices, electrical appliances, and electronic toys). Should you intend to use this product with equipment or devices which require an extremely high level or reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.



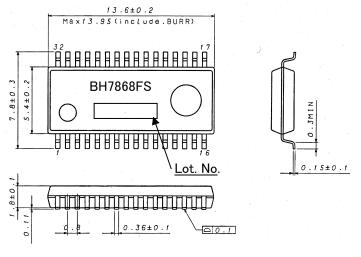
OElectrical characteristics (1/2) (Unless otherwise noted, Ta= 25°C, Vcc=5.0V)

	(1/Z) (C	Specifications			ia= 25 C,	000=5.00	
Parameter	Symbol	Min.	TYP.	Max.	Unit	Conditions	
Circuit current 1	I _{CC1}	_	90	110	mA	No signal 6ch Active MODE	
Circuit current 2	I _{CC2}	_	45	59	mA	No signal Mute1 ON (C,Y,CV channel)	
Circuit current 3	I _{CC3}	—	45	59	mA	No signal Mute2 ON	
Circuit current 4	I _{CC4}	_	5	7.5	mA	No signal Mute1 & Mute2 ON	
Maximum output level 1	V _{OM1}	2.6	3.0		Vpp	f=10 kHz, THD = 1.0% C, Py/G(BIAS), Pb/B, Pr/R	
Maximum output level 2	V_{OM2}	2.6	2.8		Vpp	f=10 kHz, THD = 1.0% CV,Y,MIX, Py,/G(CLAMP)	
Voltage gain C	G_{VC}	5.7	6.0	6.3	dB	CIN:f=3.58MHz、1Vpp	
MIX (C)	G _{VMIXC}	5.7	6.0	6.3	dB	CIN:f=3.58MHz、1Vpp	
MIX (Y)	G _{VMIXY}	5.7	6.0	6.3	dB	YIN:f=1MHz、1Vpp	
CV	G _{VCVIN}	5.7	6.0	6.3	dB	YIN:f=1MHz、1Vpp	
Y	G_{VY}	5.7	6.0	6.3	dB	YIN:f=1MHz、1Vpp	
Py/G (CLAMP/BIAS)	G _{VPY}	5.7	6.0	6.3	dB	Py/G IN : f=1MHz、1Vpp	
Pb/B	G_{VPb}	5.7	6.0	6.3	dB	Pb/B IN : f=1MHz、1Vpp	
Pr/R	G _{VPr}	5.7	6.0	6.3	dB	Pr/R IN : f=1MHz、1Vpp	
Frequency	f11	-1.5	-0.5	0.5	dB	fin=100k/6.75MHz,1Vpp	
characteristics 1 (CIN, CVIN, YIN)	f12	_	-33	-27	dB	fin=100k/27MHz、1Vpp	
Frequency	f21	-1.5	-0.5	0.5	dB	fin=100k/13.5MHz、1Vpp	
characteristics 1 (Py/G IN、Pb/B IN、Pr/R IN)	f22	_	-28	-22	dB	fin=100k/54MHz、1Vpp	
Differential Gain	D_G		1.0	—	%	1Vpp standard staircase signal	
Differential Phase	D _P	_	1.0	—	deg	1Vpp standard staircase signal	
S/N	SN	—	-75	_	dB	100% white video signal	
Cross talk	СТ	-	-60	-50	dB	fin=4.43MHz、1Vpp	
MUTE attenuation	MT	_	-60	-50	dB	CIN : f = 4.43MHz ,1Vpp YIN,CVIN, Py/GIN, Pb/BIN, Pr/RIN : f=1MHz , 1Vpp	
Group delay time 1	T1	_	40	80	ns	fin=100kHz	
Group delay time 2	T2	_	22	50	ns	fin=100kHz	
Group delay time	ΔT11		4	10	ns	fin=3.58MHz	
deviation 1 (CIN, CVIN, YIN)	ΔT12	-	6	10	ns	fin=4.43MHz	
	ΔT13	—	12	20	ns	fin=6MHz	



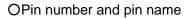
Durante		Symbol	Specifications					
Parameter	Parameter		Min.	TYP.	Max.	Unit	Conditions	
Group delay time deviation 2 (Py/G IN、Pb/B IN、Pr/R IN)		ΔT21	_	1	10	ns	fin=2MHz	
		ΔT22	_	4	10	ns	fin=8MHz	
		ΔT23	_	10	20	ns	fin=12MHz	
Channel to channel Group delay time deviation 1		∆Tch1	_	1	10	ns	C⇔Y、fin=3.58MHz	
Channel to channel Group delay time deviation 2		∆ Tch2	_	1	10	ns	Py/G⇔Pb/B⇔Pr/R、fin=2MHz	
	L	V _{SDCL}	—	0.1	0.5	V	RL=10kΩ+100kΩ S1=L,S2=L	
S-DC Output voltage	М	V _{SDCM}	1.9	2.1	2.3	V	RL=10kΩ+100kΩ S1=L,S2=H S1=H,S2=H	
	Н	V_{SDCH}	4.3	4.6	_	V	RL=10kΩ+100kΩ S1=H,S2=L	
S-DC output impedanc	е	Z _{S-DC}	_	200	_	Ω		
			2.0	_	VCC	V	MUTE OFF	
MUTE Switching voltag	je	V _{THL}	GND	_	0.7	V	MUTE ON	
SEL (CV/MIX)	SEL (CV /MIX)		2.0	_	VCC	V	CV MODE CVIN→CVOUT	
Switching voltage		V _{THL}	GND	_	0.7	V	MIX MODE CIN,YIN→CVOUT	
SEL (BIAS/CLAMP) Switching voltage		V _{THH}	2.0		VCC	V	BIAS MODE Py/G IN→Py/G OUT	
		V_{THL}	GND	_	0.7	V	CLAMP MODE Py/G IN→Py/G OUT	
S1/S2 Switching voltage		V _{THH}	2.0	_	VCC	V	High	
		V _{THL}	GND	_	0.7	V	Low	
Control pine insuit com			_	_	155	μA	VH= 4.5V	
Control pins input current		I _{IL}	_	—	20	μA	VL = 0.4V	

OOuter dimensions





OBlock diagram

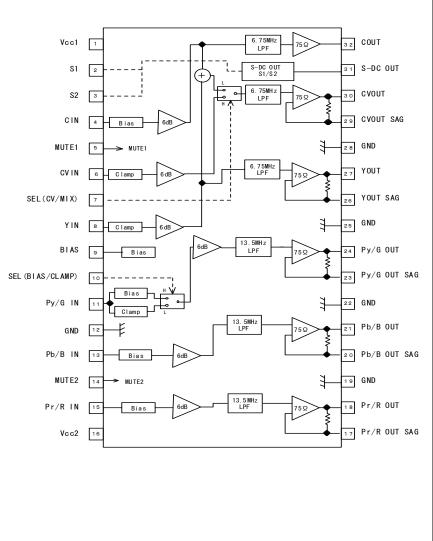


Pin name

Vcc1

Pin

<u>No.</u> 1



	VCCT
2	S1
3	S2
4	CIN
2 3 4 5 6 7 8 9	S2 CIN MUTE1 CV IN
6	CV IN
7	SEL(CV/MIX)
8	SEL(CV/MIX) YIN
9	BIAS
10	SEL(BIAS/CLAMP)
11	Py/G IN
12	GND
13	GND Pb/B IN
14	MUTE2
13 14 15	Pr/R IN
16	Vcc2
17 18	Pr/R OUTSAG
18	Pr/R OUT
19	GND
20	Pb/B OUTSAG Pb/B OUT
21	Pb/B OUT
22	GND
23 24	Py/G OUTSAG
24	Py/G OUT
25	GND YOUT SAG YOUT GND
26	YOUT SAG
27	YOUT
28	GND
29	CVOUT SAG
30	CVOUT
31	S-DCOUT
32	COUT

OCautions on use

1) Absolute maximum ratings

If applied voltage, operating temperature range, or other absolute maximum ratings are exceeded, the LSI may be damaged. Do not apply voltages or temperatures that exceed the absolute maximum ratings. If you think of a case in which absolute maximum ratings are exceeded, enforce fuses or other physical safety measures and investigate how not to apply the conditions under which absolute maximum ratings are exceeded to the LSI.

2) GND potential

Make the GND pin voltage such that it is the lowest voltage even when operating below it. Actually confirm that the voltage of each pin does not become a lower voltage than the GND pin, including transient phenomena.

3) Thermal design

Perform thermal design in which there are adequate margins by taking into account the allowable power dissipation in actual states of use.

4) Shorts between pins and miss-installation

When mounting the LSI on a board, pay adequate attention to orientation and placement discrepancies of the LSI. If it is miss-installed and the power is turned on, the LSI may be damaged. It also may be damaged if it is shorted by a foreign substance coming between pins of the LSI or between a pin and a power supply or a pin and a GND.

5) Operation in strong magnetic fields

Adequately evaluate use in a strong magnetic field, since there is a possibility of malfunction.

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